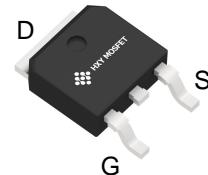




## Description

The G36N03K uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



TO-252-2L

## General Features

$V_{DS} = 30V$   $I_D = 60A$

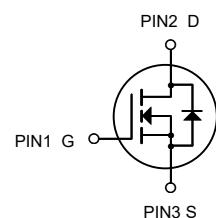
$R_{DS(ON)} < 9m\Omega$  @  $V_{GS}=10V$

## Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

## Ordering Information

| Product ID | Pack      | Brand      | Qty(PCS) |
|------------|-----------|------------|----------|
| G36N03K    | TO-252-2L | HXY MOSFET | 2500     |

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise specified)

| Symbol                  | Parameter  | Rating     | Units |
|-------------------------|--|------------|-------|
| $V_{DS}$                | Drain-Source Voltage                               | 30         | V     |
| $V_{GS}$                | Gate-Source Voltage                                | $\pm 20$   | V     |
| $I_D @ T_c=25^\circ C$  | Continuous Drain Current, $V_{GS} @ 10V$           | 60         | A     |
| $I_D @ T_c=100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$           | 40         | A     |
| $I_{DM}$                | Pulsed Drain Current                               | 110        | A     |
| EAS                     | Single Pulse Avalanche Energy                      | 57.8       | mJ    |
| $I_{AS}$                | Avalanche Current                                  | 34         | A     |
| $P_D @ T_c=25^\circ C$  | Total Power Dissipation                            | 41         | W     |
| $P_D @ T_A=25^\circ C$  | Total Power Dissipation                            | 2.42       | W     |
| $T_{STG}$               | Storage Temperature Range                          | -55 to 175 | °C    |
| $T_J$                   | Operating Junction Temperature Range               | -55 to 175 | °C    |
| $R_{\theta JA}$         | Thermal Resistance Junction-ambient (Steady State) | 62         | °C/W  |
| $R_{\theta JC}$         | Thermal Resistance Junction-Case                   | 3.6        | °C/W  |



**Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)**

| Symbol                              | Parameter                                      | Conditions   | Min. | Typ.  | Max. | Unit  |
|-------------------------------------|--|--|------|-------|------|-------|
| BV <sub>DSS</sub>                   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA   | 30   | ---   | ---  | V     |
| △BV <sub>DSS</sub> /△T <sub>J</sub> | BVDSS Temperature Coefficient                  | Reference to 25°C, I <sub>D</sub> =1mA   | ---  | 0.027 | ---  | V/°C  |
| R <sub>Ds(ON)</sub>                 | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V, I <sub>D</sub> =30A  | ---  | 7     | 9    | mΩ    |
|                                     |  | V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A   | ---  | 11    | 14   |       |
| V <sub>GS(th)</sub>                 | Gate Threshold Voltage                         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA                               | 1.2  | 1.5   | 2.5  | V     |
| △V <sub>GS(th)</sub>                | V <sub>GS(th)</sub> Temperature Coefficient    |  | ---  | -5.8  | ---  | mV/°C |
| I <sub>DSS</sub>                    | Drain-Source Leakage Current                   | V <sub>DS</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                        | ---  | ---   | 1    | uA    |
|                                     |  | V <sub>DS</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C                        | ---  | ---   | 5    |       |
| I <sub>GSS</sub>                    | Gate-Source Leakage Current                    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V   | ---  | ---   | ±100 | nA    |
| g <sub>fs</sub>                     | Forward Transconductance                       | V <sub>DS</sub> =5V, I <sub>D</sub> =30A   | ---  | 38    | ---  | S     |
| R <sub>g</sub>                      | Gate Resistance                                | V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz                                       | ---  | 2.2   | 3.5  |       |
| Q <sub>g</sub>                      | Total Gate Charge (4.5V)                       | V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A                       | ---  | 12.6  | 17.6 | nC    |
| Q <sub>gs</sub>                     | Gate-Source Charge                             |  | ---  | 4.2   | 5.9  |       |
| Q <sub>gd</sub>                     | Gate-Drain Charge                              |  | ---  | 5.1   | 7.1  |       |
| T <sub>d(on)</sub>                  | Turn-On Delay Time                             | V <sub>DD</sub> =15V, V <sub>GS</sub> =10V, R <sub>G</sub> =3.3<br>I <sub>D</sub> =15A | ---  | 4.6   | 9.2  | ns    |
| T <sub>r</sub>                      | Rise Time                                      |  | ---  | 12.2  | 22   |       |
| T <sub>d(off)</sub>                 | Turn-Off Delay Time                            |  | ---  | 26.6  | 53   |       |
| T <sub>f</sub>                      | Fall Time                                      |  | ---  | 8     | 16   |       |
| C <sub>iss</sub>                    | Input Capacitance                              | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz                                      | ---  | 1317  | 1843 | pF    |
| C <sub>oss</sub>                    | Output Capacitance                             |  | ---  | 163   | 228  |       |
| C <sub>rss</sub>                    | Reverse Transfer Capacitance                   |  | ---  | 131   | 183  |       |
| I <sub>s</sub>                      | Continuous Source Current <sup>1,5</sup>       | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current                                      | ---  | ---   | 55   | A     |
| I <sub>SM</sub>                     | Pulsed Source Current <sup>2,5</sup>           |  | ---  | ---   | 110  | A     |
| V <sub>SD</sub>                     | Diode Forward Voltage <sup>2</sup>             | V <sub>GS</sub> =0V, I <sub>s</sub> =1A, T <sub>J</sub> =25°C                          | ---  | ---   | 1.2  | V     |
| t <sub>rr</sub>                     | Reverse Recovery Time                          | I <sub>F</sub> =30A, dI/dt=100A/μs, T <sub>J</sub> =25°C                               | ---  | 9.2   | ---  | nS    |
| Q <sub>rr</sub>                     | Reverse Recovery Charge                        |  | ---  | 2     | ---  | nC    |

Note :

- 1 .The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3.The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=25V,V<sub>GS</sub>=10V,L=0.1mH,I<sub>AS</sub>=34A
- 4.The power dissipation is limited by 175°C junction temperature
- 5.The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub> , in real applications , should be limited by total power dissipation.



## Typical Characteristics

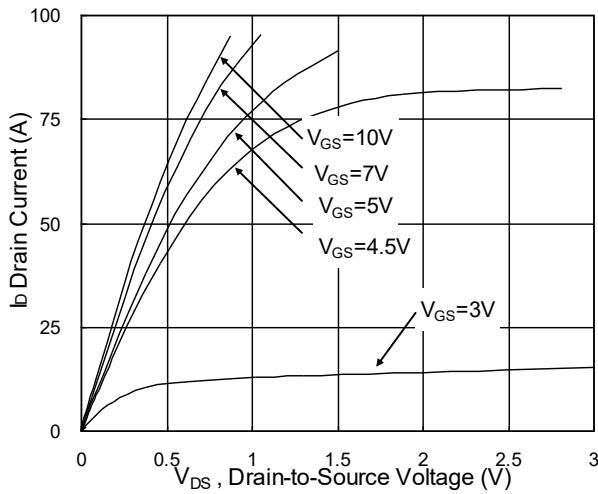


Fig.1 Typical Output Characteristics

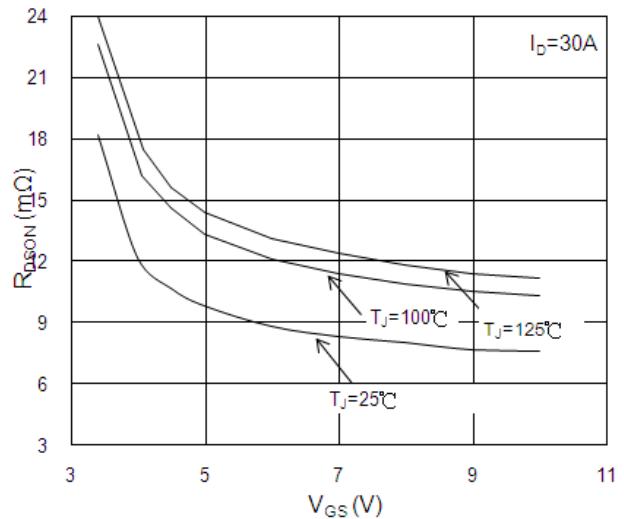


Fig.2 On-Resistance vs. G-S Voltage

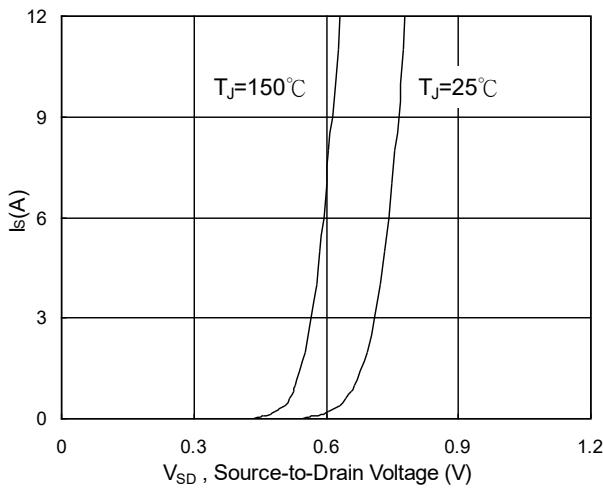


Fig.3 Forward Characteristics of Reverse

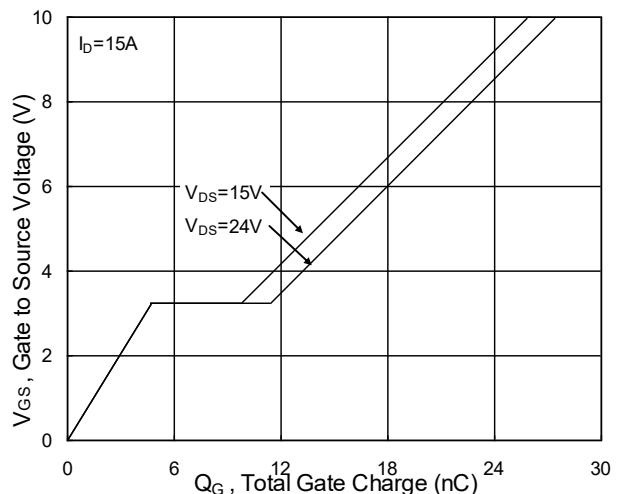


Fig.4 Gate-Charge Characteristics

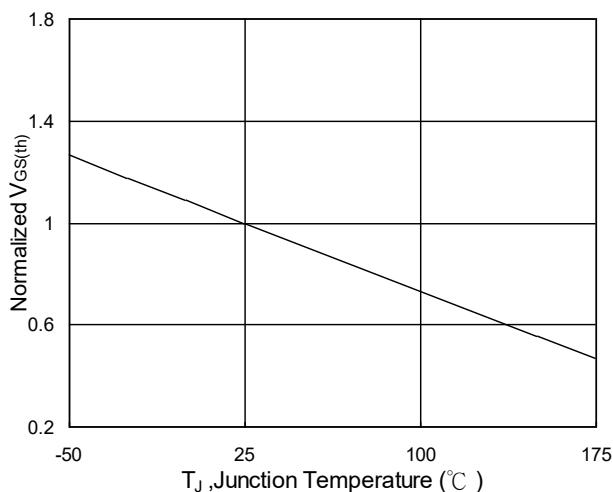


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

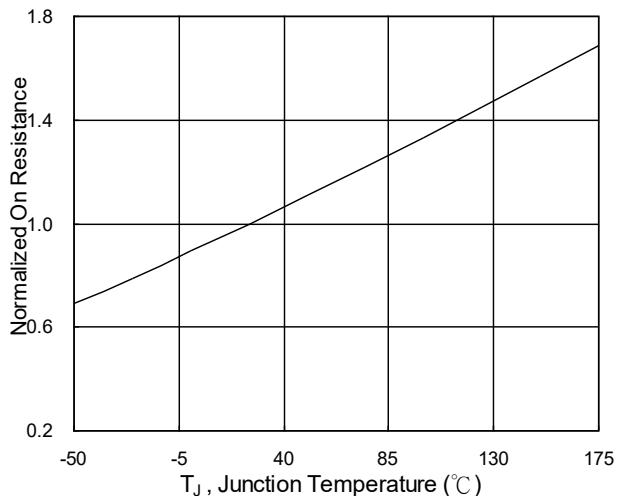


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

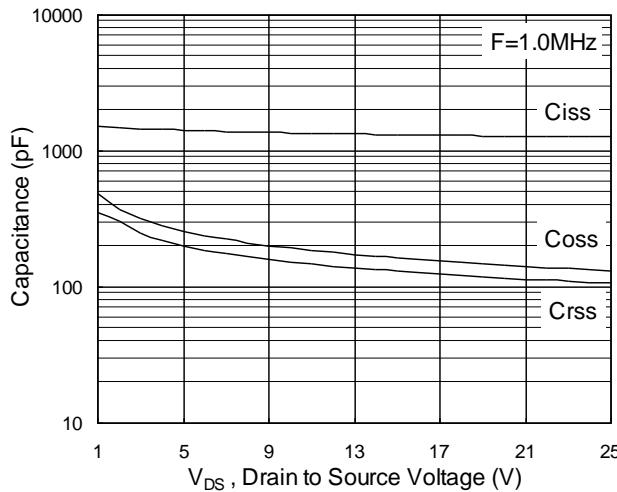


Fig.7 Capacitance

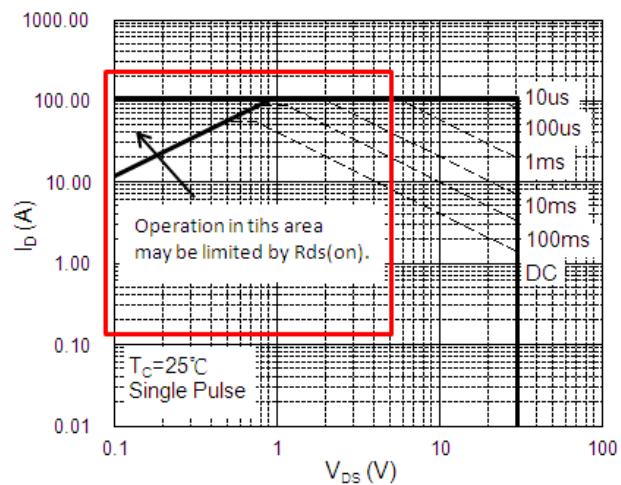


Fig.8 Safe Operating Area

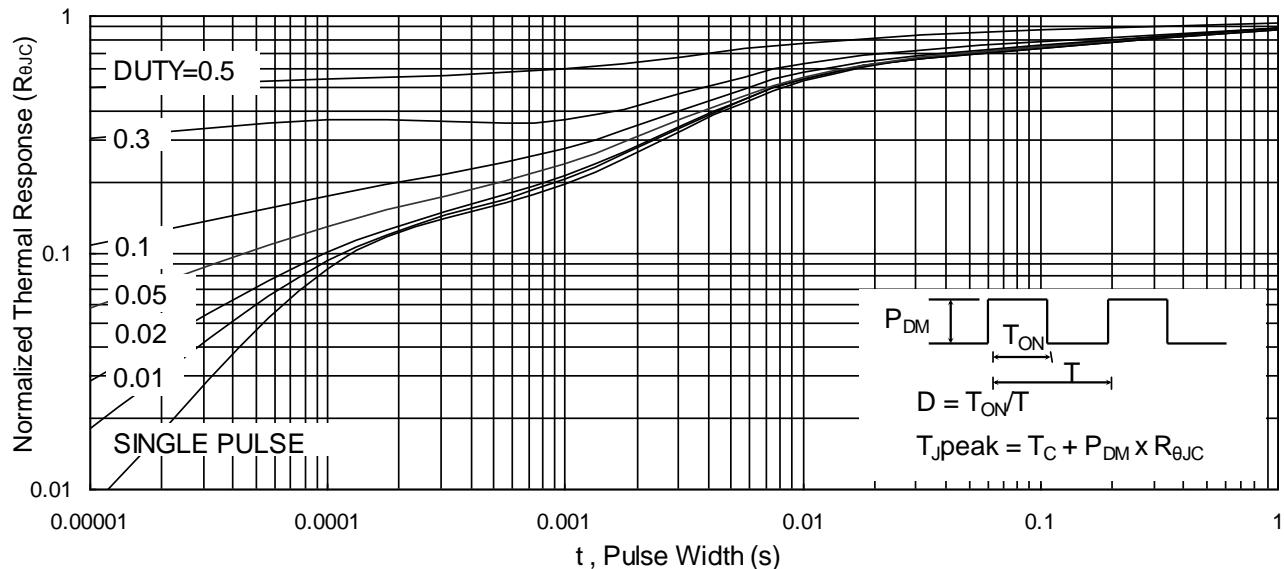


Fig.9 Normalized Maximum Transient Thermal Impedance

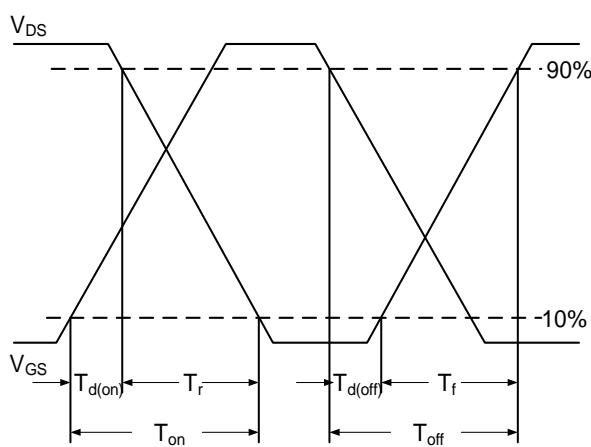


Fig.10 Switching Time Waveform

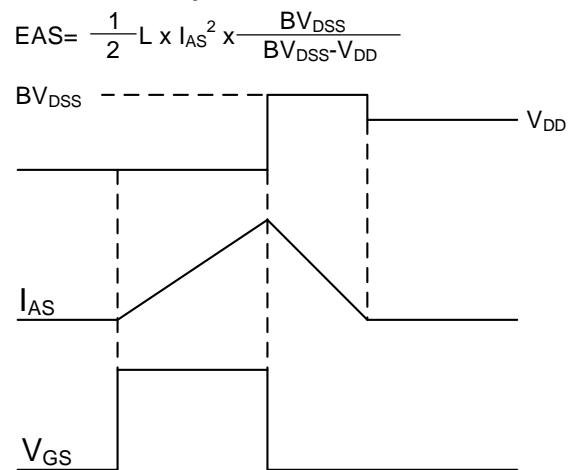
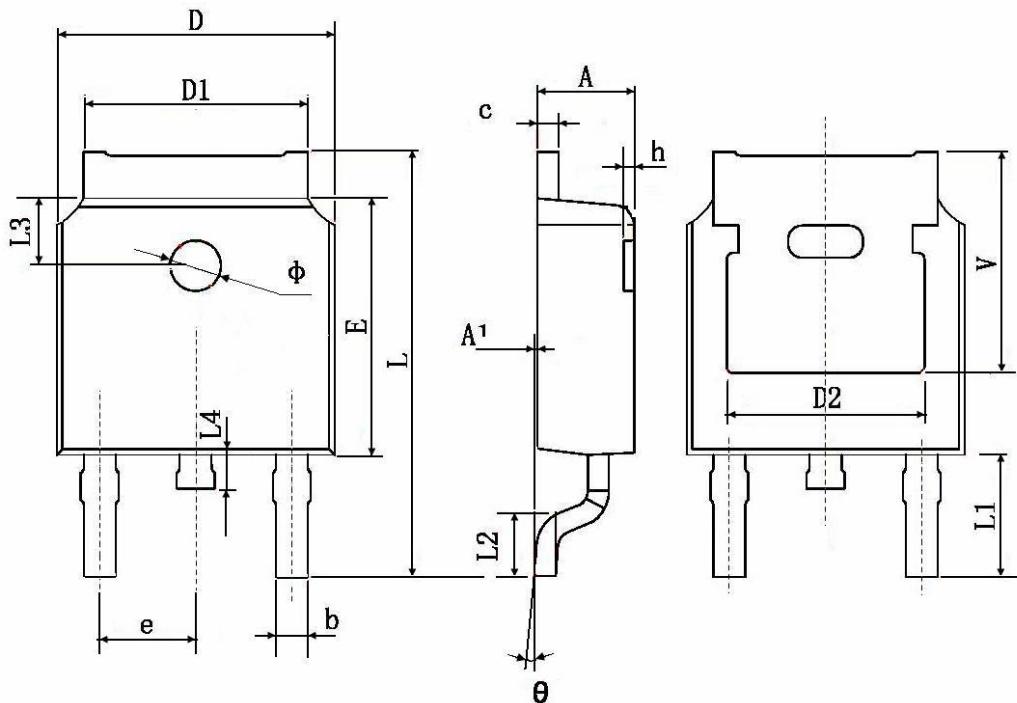


Fig.11 Unclamped Inductive Switching Waveform



## TO-252-2L Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 0.483 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |



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